

C1812X683KATACAUTO

SMD Auto X8G HT150C Flex, Ceramic, 0.068 uF, 10%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, Automotive Grade, 1812, 2.3



General Information		
Series	SMD Auto X8G HT150C Flex	
Style	SMD Chip	
Description	SMD, MLCC, High Temperature, Ultra-Stable, Automotive Grade	
Features	High Temperature, Ultra-Stable, Automotive Grade	
RoHS	Yes	
Termination	Flexible Termination	
Marking	No	
Qualifications	AEC-Q200	
AEC-Q200	Yes	
Typical Component Weight	87 mg	
Shelf Life	78 Weeks	
MSL	1	

0.068 uF

Dimensions	
Chip Size	1812
L	4.5mm +/-0.4mm
W	3.2mm +/-0.3mm
Т	1.6mm +/-0.20mm
S	2.3mm MIN
В	0.7mm +/-0.35mm

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L	4.5mm +/-0.4mm	Measurement Condition	1 kHz 1.0Vrms
W	3.2mm +/-0.3mm	Tolerance	10%
Т	1.6mm +/-0.20mm	Voltage DC	250 VDC
S	2.3mm MIN	Dielectric Withstanding Voltage	625 VDC
В	0.7mm +/-0.35mm	Temperature Range	-55/+150°C
		Temp. Coefficient	X8G
Packaging Specifications		Capacitance Change with	30 ppm/C, 1kHz 1.0Vrms
Packaging	T&R, 180mm, Plastic Tape	Reference to +25°C and 0 VDC Applied (TCC)	
Packaging Quantity 1000	Dissipation Factor	0.1% 1 kHz 1.0Vrms	
		Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours
		Insulation Resistance	14.7059 GOhms

Specifications Capacitance

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